

Certificate TW19/10223

The management system of

King Yuan Electronics Co., Ltd.

No. 118, Chung-Hua Rd., Chu-Nan, Miao-Li Hsien, 350, Taiwan, R.O.C.

has been assessed and certified as meeting the requirements of
ISO 13485:2016
EN ISO 13485:2016

For the following activities

1. Manufacturing of Semiconductor through Grinding, Dicing, Probing, Testing and Backend Processing for Active Medical Device
2. Manufacturing of IC Package and Modules Assembly for Active Medical Device

This certificate is valid from 25 April 2022 until 25 April 2025 and remains valid subject to satisfactory surveillance audits.

Issue 2. Certified since 25 April 2019.

Certified activities performed by additional sites listed on subsequent pages.

Authorised by



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King Yuan Electronics Co., Ltd.



ISO 13485:2016
EN ISO 13485:2016

Issue 2
Sites
King Yuan Electronics Co., Ltd. No. 118, Chung-Hua Rd., Chu-Nan, Miao-Li Hsien, 350, Taiwan, R.O.C. 1. Manufacturing of Semiconductor through Grinding, Dicing, Probing, Testing and Backend Processing for Active Medical Device 2. Manufacturing of IC Package and Modules Assembly for Active Medical Device
King Yuan Electronics Co., Ltd. No. 81, Sec. 2, Gongdaowu Rd., Hsin-Chu City, 300, Taiwan, R.O.C. 1. Manufacturing of Semiconductor through Grinding, Dicing, Probing, Testing and Backend Processing for Active Medical Device 2. Manufacturing of IC Package and Modules Assembly for Active Medical Device
King Yuan Electronics Co., Ltd. No. 8, Tongke N. Rd., Tongluo, Miao-Li Hsien, 366, Taiwan, R.O.C. 1. Manufacturing of Semiconductor through Grinding, Dicing, Probing, Testing and Backend Processing for Active Medical Device 2. Manufacturing of IC Package and Modules Assembly for Active Medical Device
King Yuan Electronics Co., Ltd. No. 8, Ln. 228, Chung-Hua Rd., Chu-Nan, Miao-Li Hsien, 350, Taiwan, R.O.C. 1. Manufacturing of Semiconductor through Grinding, Dicing, Probing, Testing and Backend Processing for Active Medical Device 2. Manufacturing of IC Package and Modules Assembly for Active Medical Device



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